



Edition 2.0 2020-04 REDLINE VERSION

INTERNATIONAL STANDARD





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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FIELD DEVICE INTEGRATION (FDI) -

Part 109-1: Profiles - HART® and WirelessHART®

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1-2020

International Standard IEC 62769-109-1 has been prepared by subcommittee 65E: Devices and integration in enterprise systems, of IEC technical committee 65: Industrial-process measurement, control and automation.

This second edition cancels and replaces the first edition published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) support for generic protocol extension for faster adoption of other technologies;
- b) support for Package Developers to build EDDs targeted for today's EDD bases system under a single development tool.

The text of this International Standard is based on the following documents:

CDV	Report on voting
65E/624/CDV	65E/687A/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the SONEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title Field Device Integration (FDI), can be found on the IEC website

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended

INTRODUCTION

The International Electrotechnical Commission (IEC) draws attention to the fact that it is claimed that compliance with this document may involve the use of patents concerning

- a) method for the supplying and installation of device-specific functionalities, see Patent Family DE10357276;
- b) method and device for accessing a functional module of automation system, see Patent Family EP2182418;
- c) methods and apparatus to reduce memory requirements for process control system software applications, see Patent Family US2013232186;
- d) extensible device object model, see Patent Family US12/893,680.

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FIELD DEVICE INTEGRATION (FDI) -

Part 109-1: Profiles - HART® and WirelessHART®

1 Scope

This part of IEC 62769 specifies an FDI profile of IEC 62769 for IEC 61784-1_CP 9/1 $(HART^{\otimes})^{1}$ and IEC 61784-1_CP 9/2 $(WirelessHART^{\otimes})^{1}$.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62541-100:2015, OPC Unified Architecture Specification - Part 100; Device Interface

IEC 62769-4:2015-2, Field device integration (FDI) - Part 4. FDI Packages

NOTE IEC 62769-4 is technically identical to FDL 2024

IEC 62769-5, Field device integration (FDI) - Rart 5: FDI Information Model

NOTE IEC 62769-5 is technically identical to FDI-2025.

IEC 62769-7, Field device integration (FDI) Part 7: FDI Communication Devices

NOTE IEC 62769-7 is technically identical to FDI 2027.

3 Terms, definitions, abbreviated terms and acronyms conventions

3.1 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 62541-100, IEC 62769-4, IEC 62769-5 and IEC 62769-7 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

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² Under preparation. Stage at the time of publication: IEC/RFDIS 62769-4:2020.

3.2 Abbreviated terms and acronyms

For the purposes of this document, the following abbreviations apply:

CP Communication profile (see IEC 61784-1 or IEC 61784-2)

CPF Communication profile family (see IEC 61784-1 or IEC 61784-2)

EDD Electronic device description (see IEC 61804)

EDDL Electronic device description language (see IEC 61804)

FDI Field device integration FSK Frequency-Shift-Keying

HCF HART Communication Foundation

ID Identification

IM Information ModelIP Internet protocolPDU Protocol data unitPSK Phase-Shift-Keying

TCP Transmission Control Protocol (see IETF RFC 793)

UDP User Datagram Protocol (see IETF RFC 768)

XML Extended Extensible markup language

3.3 Conventions

3.3.1 EDDL syntax

This document specifies content for the EDD component that is part of FDI Communication Packages. EDDL syntax uses the font source New. EDDL syntax is used for method signature, variable, data structure and component declarations.

3.3.2 XML syntax

XML syntax examples use font Courter New. The XML syntax is used to describe XML document schema.

EXAMPLE <xs:simpleType name="ExampleT">

3.3.3 Capitalizations

The IEC 62769 series uses capitalized terms to emphasize that these terms have an FDI specific meaning.

Some of these terms using an acronym as a prefix, for example

- FDI Client or
- FDI Server.

Some of these terms are compound terms such as:

- · FDI Communication Servers or
- Profile Package.

Parameter names or attributes are concatenated to a single term, where the original terms start in this term with a capital letter such as:

ProtocolSupportFile or

ProtocolType.

Parameter names or attributes can also be constructed by using an underscore character to concatenate two or more terms like:

- PROFILE_ID or
- HART Network.

4 Profile for CP 9/1 (HART®) or CP 9/2 (WirelessHART®)

4.1 General

This profile document to the FDI specification in IEC 62769 specifies selects the protocol specifics needed for FDI Packages describing FDI Communication Servers, gateways and devices.

4.2 Catalog profile

4.2.1 Protocol support file

No additional file is required for CP 9/1 or CP 9/2 FDI/Device Paskages

Device information files provide metadata for the dynamic runtime data that is supplied by the device. This metadata is a subset of information that is contained in the EDD. The device information files may be extracted from the package by light-weight gateway or server implementations to exchange runtime device information with minimal implementation overhead. Device information files do not replace the need for the EDD part because device information files only contain a subset of the information from the EDD, and do not provide any user-interface elements.

The formats of the Device Information Files are described in Table 1.

Table 1 - Device Information Files 893b499068e/iec-62769-109-1-202

Part	Content			
Content Type	Not specified here			
Root Namespace	Not specified here			
Source http://fdi-cooperation.com/2010/relationships/attachment-protocol Relationship				
Filename	Not specified here			

The Device Information Files are specified in FCG AG21073.

4.2.2 CommunicationProfile definition

IEC 62769-4 defines a CommunicationProfileT—enumeration string type for the Catalog XML schema. Table 2 defines the CP 9/1 specific values for this enumeration.

Table 2 - CommunicationProfile definition

CommunicationProfile	Description
hart_fsk	CP 9/1 device type that supports an FSK physical layer (Frequency-Shift-Keying on a pair of wires)
hart_psk	CP 9/1 device type that supports a PSK physical layer (Phase-Shift-Keying on a pair of wires). Devices supporting PSK are required to also inherently support FSK, and therefore PSK will always be used only in combination with at least FSK.

4.2.3 Profile device

A Profile Package shall provide the catalog values for profile devices, enabling the FDI Server to leverage a generic device description, if a specific one is not available. The definitions in Table 3 focus on catalog content that is vendor independent.

Table 3 - Catalog values for profile devices

Element	Attribute	Content
PackageType	_	Profile
DeviceModel	-	Empty
Manufacturer		Empty

4.2.4 Protocol version information

IEC 62769-4 defines an element type named InterfaceT for the Catalog XML Schema. Element type InterfaceT contains an element named Version which is supposed to provide version information about the applied communication protocol profile. The value has to follow the IEC 62769-4 defined version information schema defined in element type VersionT. Subclause 4.2.4 describes how to apply the currently known protocol versions for CP 9/1 or CP 9/2 entries in the device catalog. The general rule is to use the Universal Revision of the protocol for the major version part of VersionT, and the value "0" for the minor version and build parts. Table 4 shows the Protocol Version Information.

Table 4 - Protocol Version Information

Protocol Version	InterfaceT Version value
HART Universal Revision 5	5.0.0
HART Universal Revision 6	6.0.0
HART Universal Revision 7	7.0.0

The Protocol Version defined in a package is provided for informational purposes only and shall not be used to determine the compatibility or applicability of a package to a device.

4.3 Associating a Package with a CP 9/1 device

4.3.1 Device type identification mapping

CP 9/1 device types are uniquely identified by parameters Manufacturer, Model and DeviceRevision. These parameters are used to associate a given device instance to an FDI Device Package. These parameters are mapped to the FDI Device Package Catalog according to Table 5.

Table 5 - Device type catalog mapping

Catalog element	CP mapping (see 5.4.2)
Manufacturer element of InterfaceT (IEC 62769-4:2015, Clause E.11)	Manufacturer String format "0xdddd" where dddd is the Manufacturer number in hexadecimal format.
DeviceModel element of InterfaceT (IEC 62769-4:2015, Clause E.11)	Model String format "0xdddd" where dddd is the Model number in hexadecimal format.
DeviceRevision element ListOfSupportedDeviceRevisionsT (IEC 62769-4:2015, Clause E.21)	DeviceRevision String format "x.0.0" where x is the DeviceRevision in decimal format (no leading zeros).

Catalog element	CP mapping (SeeTable A.)
Manufacturer element of InterfaceT (IEC 62769-4:-, Clause E.10)	Manufacturek String format "0xdddd" where dddd is the MANUFACTURER_ID in hexadecimal format.
DeviceModel element of InterfaceT (IEC 62769-4:-, Clause E.10)	Model String format "0xdddd" where dddd is the DEVICE TYPE in hexadecimal format.
DeviceRevision element	DeviceRevision
ListOfSupportedDeviceRevisionsT (IEC 62769-4:-, Clause E.20)	String format "x.0.0" where x is the DEVICE_REVISION in decimal format (no leading zeros).

4.3.2 Device type revision mapping

Each device type is identified as per 4.3.1 If a package with matching DeviceRevision is not available, any CP 9/1 FDI package for a corresponding manufacturer and model shall always be compatible with a field device as long as the device revision of the field device is equal to or greater than the device revision specified in the FDI package.

4.4 Information Model mapping

4.4.1 ProtocolType definition

Table 6 defines the ProtocolType used to identify CP 9/1 network communications.

Table 6 - ProtocolType HART definition

Attribute	Value				
BrowseName	HART				
IsAbstract	False				
References NodeClass BrowseName DataType TypeDefinition ModellingRu				ModellingRule	
Inherits the properties of ProtocolType defined in IEC 62541-100.					

4.4.2 DeviceType mapping

Each device type inherits the properties of DeviceType. The mapping of the inherited properties from DeviceType is defined in Table 7.

Table 7 - Inherited DeviceType Property mapping

Property	Foundation mapping		
SerialNumber	3-byte unique ID of a device, returned in bytes 9 to 11 of Command 0 or Command 11 or Command 21		
RevisionCounter	2-byte configuration change counter, returned in bytes 14 and 15 of Command 0 or Command 11 or Command 21.		
	-1 (not defined) for HART revision 5 devices		
Manufacturer	For HART revision 7 or higher devices:		
	2-byte manufacturer code of a device, returned in bytes 17 and 18 of Command 0 or Command 11 or Command 21.		
	For HART revision 6 or lower devices:		
	Most significant byte shall be fixed to 0, and the least significant byte is returned in byte 1 of Command 0 or Command 1 for Command 21		
Model	2-byte extended device type of a device, returned in bytes 1 and 2 of Command 0 or Command 11 or Command 21		
DeviceManual	Entry text string (not supported) a		
DeviceRevision	1-byte device revision level of a device, returned in byte 5 of Command 0 or Command 11 or Command 21		
SoftwareRevision	1-byte software revision level of a device, returned in byte 6 of Command 0 or Command 11 or Command 21		
HardwareRevision	1-byte hardware revision level of a device, returned in byte 7 (only 5 most significant bits) of Command 0 or Command 11 or Command 21		

	Property	Coundation mapping	
	SerialNumber	Unique ID of a device, mapped to SERIAL_NUMBER of IdentificationT.	
	RevisionCounter	Configuration change counter, mapped to REV_COUNTER of Identification	
ittps://s	Manufacturer	String taken from FDI package catalog (ManufacturerName from PackageT)	
	Model	String taken from FDI package catalog (Name of DeviceTypeT, which is a localized name)	
	DeviceManual	Entry text string (not supported) a	
Device revision level of a device, mapped to IdentificationT		Device revision level of a device, mapped to DEVICE_REVISION of IdentificationT	
Software revision level of a device, mapped t IdentificationT		Software revision level of a device, mapped to SOFTWARE_REVISION of IdentificationT	
	HardwareRevision	Hardware revision level of a device, mapped to HARDWARE_REVISION of IdentificationT	
Device manuals are exposed as attachments of the FDI Device Package.			

4.4.3 FunctionalGroup Identification definition

As defined in IEC 62541-100, each device representation in the FDI Server hosted Information Model shall contain a protocol specific FunctionalGroup called Identification. This FunctionalGroup organizes variables found in the device type instance. The FunctionalGroup Identification for CP 9/1 is defined in Table 8.

Table 8 - Identification parameters

BrowseName	DataType	Optional/Mandatory
MANUFACTURER_ID	UInt16	Mandatory